

UNISONIC TECHNOLOGIES CO., LTD

5NM65 Preliminary Power MOSFET

5.0A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

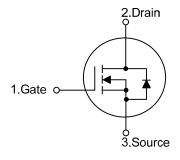
■ DESCRIPTION

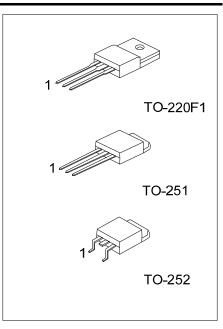
The **UTC 5NM65** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(on)}$ < 1.2 Ω @ V_{GS} =10V, I_D =2.5A
- * Improved dv/dt capability
- * Fast switching
- * 100% avalanche tested

■ SYMBOL

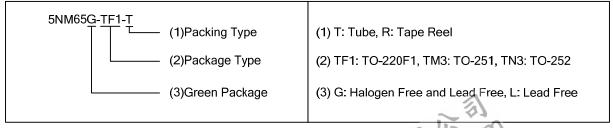




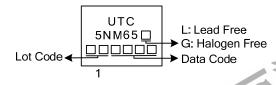
ORDERING INFORMATION

| Ordering Number | | Dookaga | Pin Assignment | | | Dooking | |
|-----------------|--------------|----------|----------------|---|---|-----------|--|
| Lead Free | Halogen Free | Package | 1 | 2 | 3 | Packing | |
| 5NM65L-TF1-T | 5NM65G-TF1-T | TO-220F1 | G | D | S | Tube | |
| 5NM65L-TM3-T | 5NM65G-TM3-T | TO-251 | G | D | S | Tube | |
| 5NM65L-TN3-R | 5NM65G-TN3-R | TO-252 | G | D | S | Tape Reel | |

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|---|-----------------|------------------|------------|------|
| Drain-Source Voltage | | V_{DSS} | 650 | V |
| Gate-Source Voltage | | V_{GSS} | ±30 | V |
| Drain Current | Continuous | I _D | 5 | Α |
| | Pulsed (Note 2) | I_{DM} | 20 | Α |
| Avalanche Current (Note 2) | | I _{AR} | 1.1 | Α |
| Avalanche Energy Single Pulsed (Note 3) | | E _{AS} | 87 | mJ |
| Peak Diode Recovery dv/dt (Note 4) | | dv/dt | 3.7 | V/ns |
| Power Dissipation | TO-220F1 | Б | 36 | W |
| | TO-251/TO-252 | P_D | 54 | W |
| Junction Temperature | | T _J | +150 | °C |
| Storage Temperature | | T _{STG} | -55 ~ +150 | °C |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 144mH, I_{AS} = 1.1A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 4. $I_{SD} \le 5.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|---------------------|---------------|---------------|---------|------|
| Junction to Ambient | TO-220F1 | 0 | 62.5 | °C/W |
| | TO-251/TO-252 | θ_{JA} | 110 | °C/W |
| Junction to Case | TO-220F1 | θ_{JC} | 3.47 | °C/W |
| | TO-251/TO-252 | | 2.31 | °C/W |



■ **ELECTRICAL CHARACTERISTICS** (T_J =25°C, unless otherwise specified)

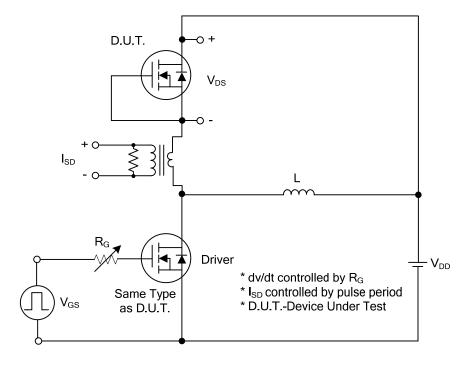
| PARAMETER | | SYMBOL | TEST CONDITIONS | | TYP | MAX | UNIT |
|---|-------------------|---------------------|---|-----|------|------|------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | | BV_{DSS} | I _D =250μA, V _{GS} =0V | 650 | | | V |
| Drain-Source Leakage Current | | I _{DSS} | V _{DS} =650V, V _{GS} =0V | | | 10 | μΑ |
| Gate-Source Leakage Current | Forward | I _{GSS} | V_{GS} =+30V, V_{DS} =0V | | | +100 | nA |
| | Reverse | | V _{GS} =-30V, V _{DS} =0V | | | -100 | nA |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | | $V_{GS(TH)}$ | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | | | 4.5 | V |
| Static Drain-Source On-State Resistance | | R _{DS(ON)} | V _{GS} =10V, I _D =2.5A | | | 1.2 | Ω |
| DYNAMIC PARAMETERS | _ | | | - | | | |
| Input Capacitance | Input Capacitance | | | | 330 | | рF |
| Output Capacitance | | Coss | V_{GS} =0V, V_{DS} =25V, f=1.0MHz | | 165 | | pF |
| Reverse Transfer Capacitance | | C_{RSS} | | | 20 | | pF |
| SWITCHING PARAMETERS | _ | | | - | | | |
| Total Gate Charge (Note 1) | | Q_G | V _{DS} =50V, V _{GS} =10V, I _D =1.3A, | | 42 | | nC |
| Gate to Source Charge | | Q_GS | $I_D=100\mu A$ (Note 1, 2) | | 4.0 | | nC |
| Gate to Drain Charge | | Q_GD | 10-100μA (Note 1, 2) | | 12 | | nC |
| Turn-on Delay Time (Note 1) | | $t_{D(ON)}$ | | | 40 | | ns |
| Rise Time | | t_R | V_{DS} =30V, V_{GS} =10V, I_{D} =0.5A, R_{G} =25 Ω (Note 1, 2) | | 70 | | ns |
| Turn-off Delay Time | | $t_{D(OFF)}$ | | | 140 | | ns |
| Fall-Time | | t_{F} | | | 38 | | ns |
| SOURCE- DRAIN DIODE RATIN | NGS AND CH | ARACTERIST | rics | | | | |
| Maximum Body-Diode Continuous Current | | I _S | | | | 5 | Α |
| Maximum Body-Diode Pulsed Current | | I _{SM} | | | | 20 | Α |
| Drain-Source Diode Forward Voltage (Note 1) | | V_{SD} | I _S =5.0A, V _{GS} =0V | | | 1.4 | V |
| Reverse Recovery Time (Note 1) | | t _{rr} | I _S =5.0A, V _{GS} =0V, | | 410 | | nS |
| Reverse Recovery Charge | | Q _{rr} | dI _F /dt =100A/µs | | 3.62 | | μC |

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

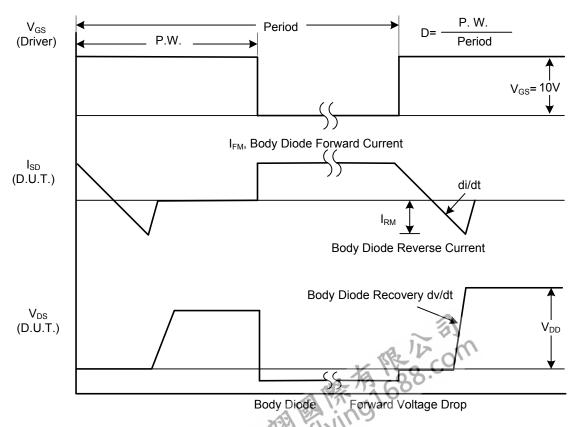


^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

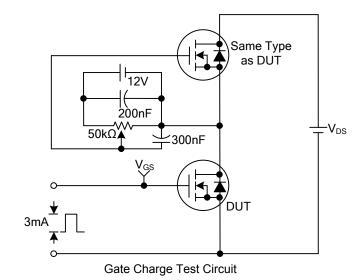


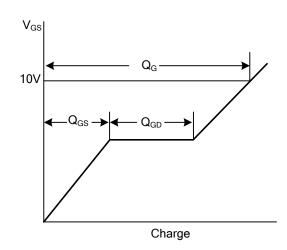
Peak Diode Recovery dv/dt Test Circuit



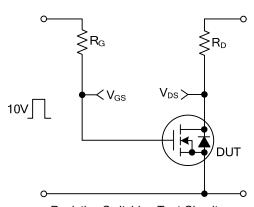
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)

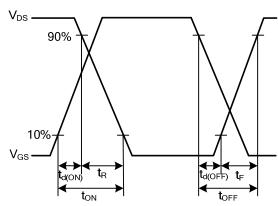




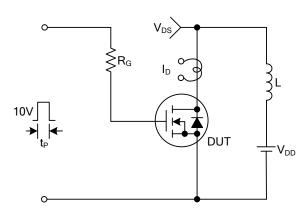
Gate Charge Waveforms



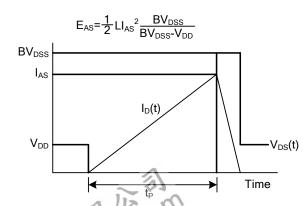
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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